

Supporting Information

Two-Stage Filamentary Mechanism in High-Performance Organic Resistive Switch

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Table S1. A summary of resistive switching characteristics of organic-ReRAM devices and governing switching mechanisms.

Device	Retention	Endurance	On/OFF	Voltage	Memory	Mechanis	Devi	Ref
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structure	[s]	[Cycle]		range [V]	behavior	mechanism	cell measurement	
Al/4C ₂ I PN- P ₃ HT/ITO	10 ⁴	150	10 ⁵	-6/3.3	Non-Volatile	Trapping and de-trapping of charges	-	1
Ag/Pectin/FTO	10 ⁸	27	10 ⁴	3/-2.8	Non-Volatile	Filamentary switching	-	2
Al/D-A-A/ITO	10 ⁴	60	10 ⁴	-3.5/1.8	Non-Volatile	Trap-based hole transfer	-	3
Al/F8BT/ITO	- a)	-	10	-5/+5	Non-Volatile	The transition of trap-limited SCLC to trap-filled SCLC	-	4
Al/Carbazole/ITO	10 ³	-	10 ³	-1.5/+4	Non-Volatile	Formation and dissociation of a charge-transfer state under the applied voltage	-	5
Mg/Pectin/Mg	10 ⁶	160	20	Current bias	Nonvolatile	Filamentary switching	-	6
Au/PE DOT: PSS/Ag clusters /PMMA /ITO	10 ⁴	50	10 ²	-10/+10	Nonvolatile	Filamentary switching	10	7
Ag/2D Imine/ITO	10 ³	200	10 ³	-3/+1	Flash	Filamentary switching	-	8
Au/MQDs-PVP/ITO	10 ³	-	10 ²	-3.8/-2.2	Flash and WORM	Trapping and De-trapping of charge carriers	20	9
Al/PVK/ITO	10 ⁴	15	10 ³	-2.7/+1.4	Flash	Filamentary switching	-	10
Cu/Par	10 ⁴	10 ³	10 ³	-6/+1	Flash	Copper	8	11

ylene/I TO						filament formation		
Al/ PDA coated yarn	10 ⁶	-	10 ³	-1.5/+1.5	Nonvolati le	carbon- based electric filament	25	¹²
Ag/PVCI /Au	5000	300	-	-1.8/+1.8	Nonvolati le	Conductiv e filament	10	¹³
Al/PDI/I TO	10⁵	>250	10³	-1.5/+2	Non- Volatile	Al and oxygen vacancy filament s	10	Thi s wo rk

a) No data in this publication.

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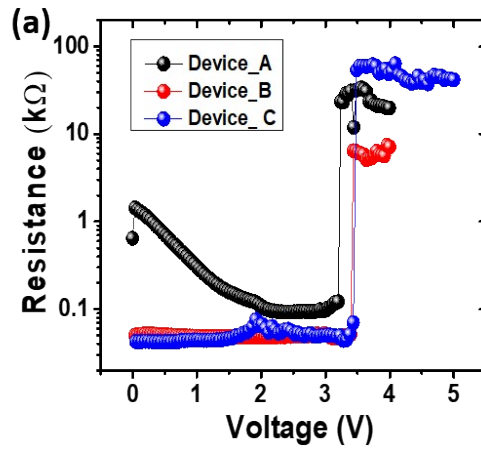


Figure S1. Reproducible electroformation of three devices.

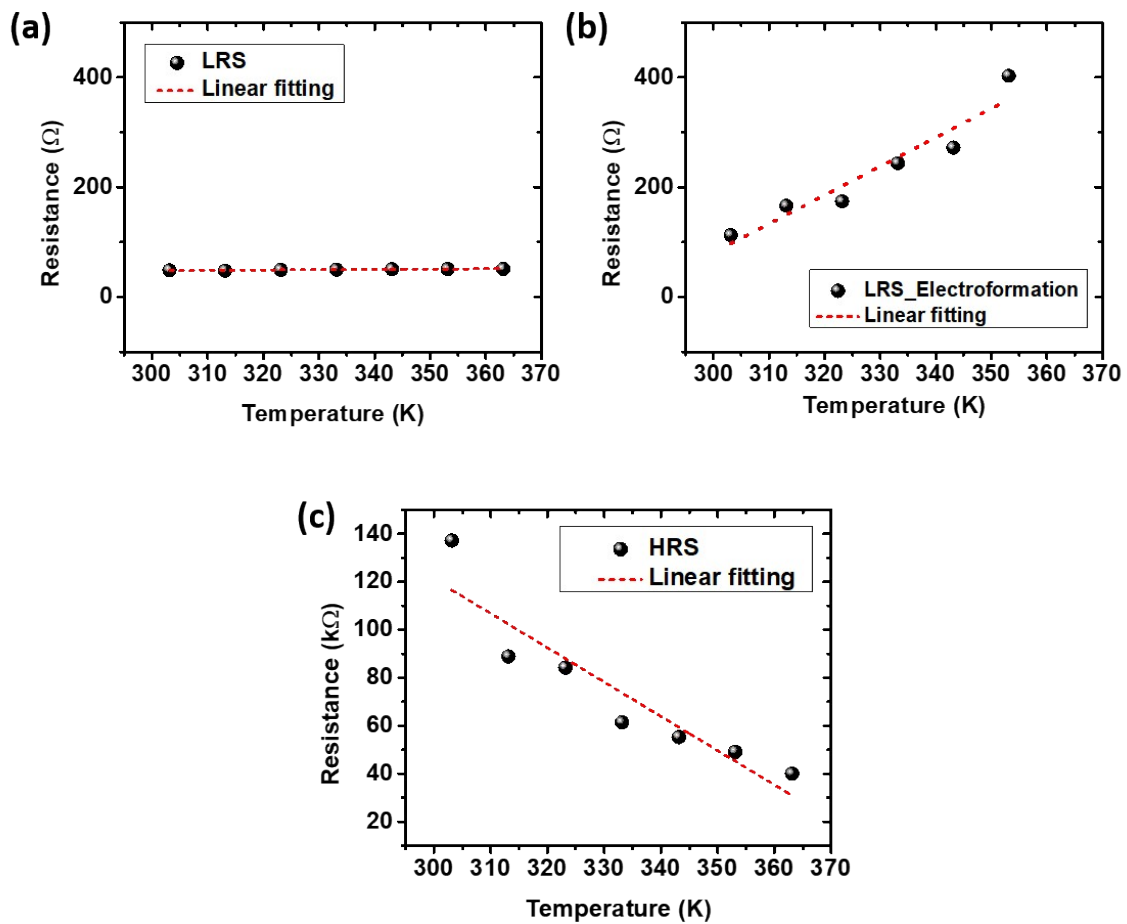


Figure S2. Temperature dependence of the resistance states of the device: (a) LRS, (b) LRS just after electroformation, (c) HRS.

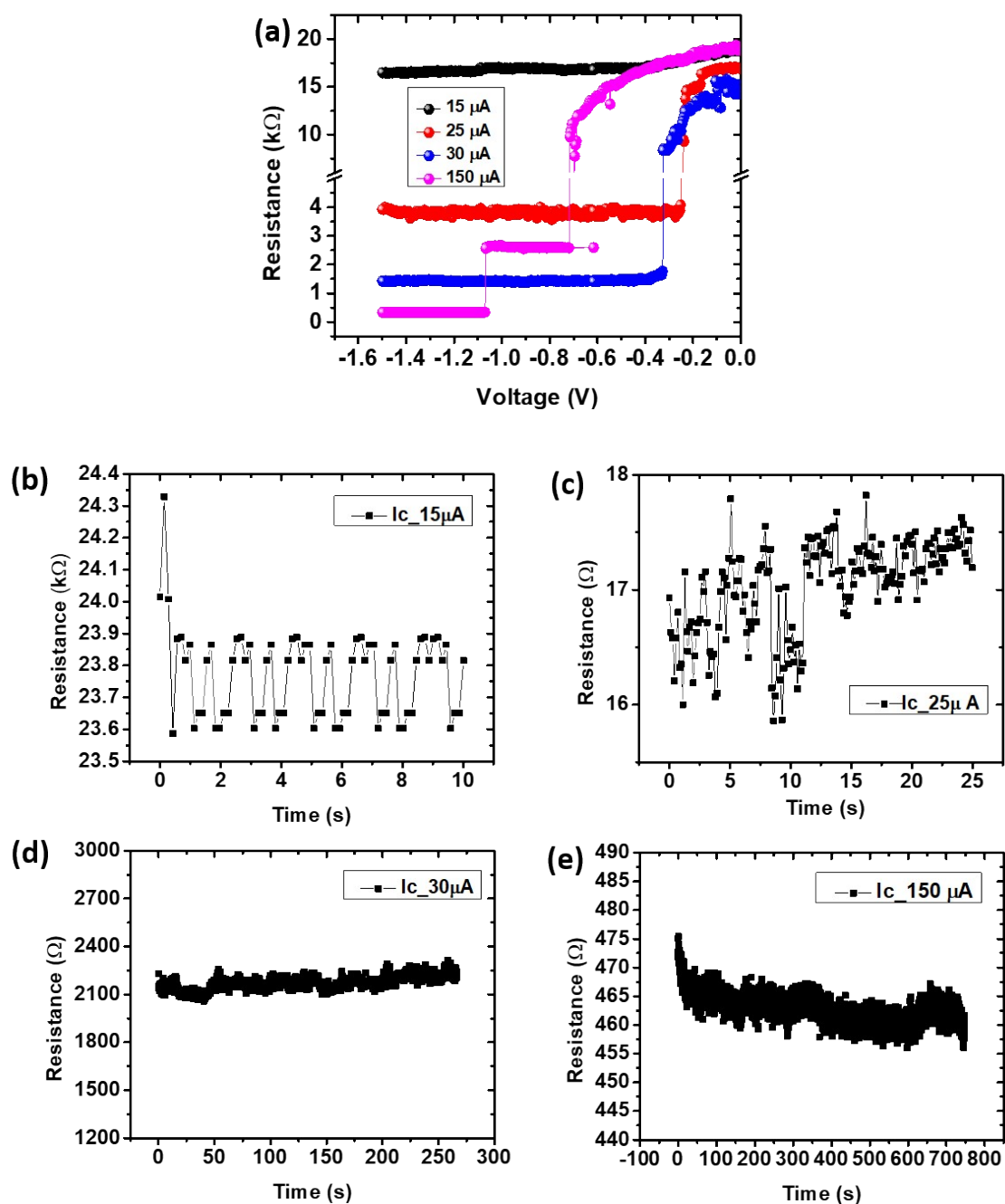


Figure S3. (a) Compliance current (I_{CC}) dependent switching and stability of the filament of the AI/PVK/ITO device. state of the resistance after switching at (b) 15 μA I_{CC} , (c) 25 μA I_{CC} , (d) 30 μA I_{CC} , (e) 150 μA I_{CC} ,

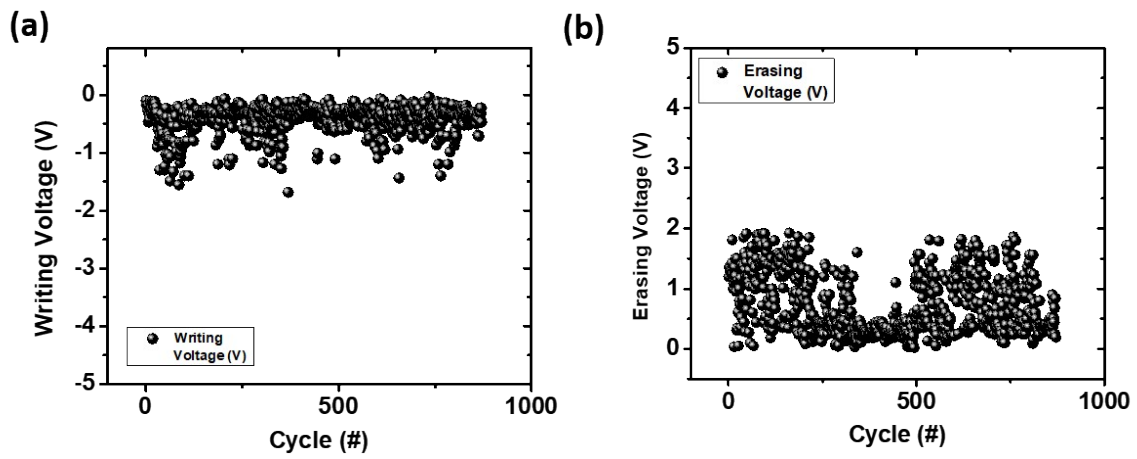
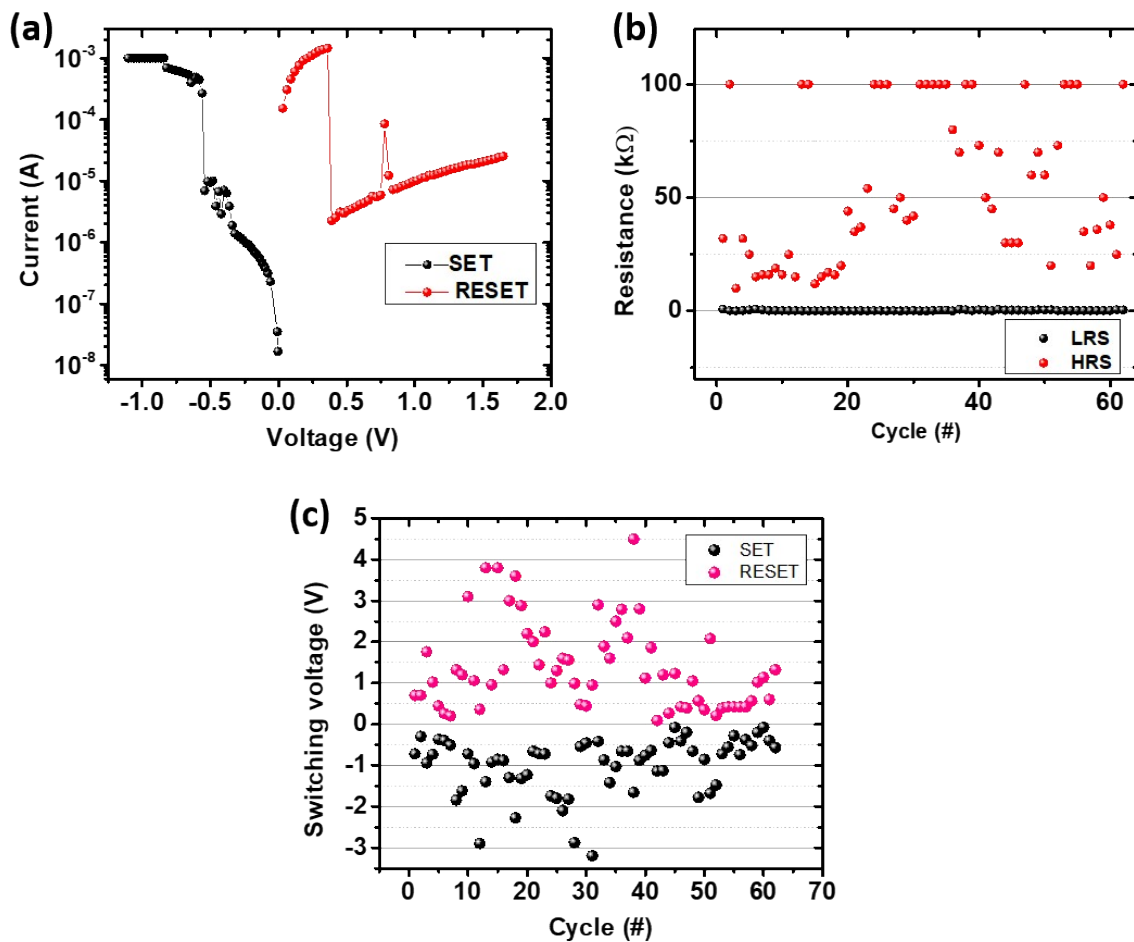


Figure S4. (a), (b) switching voltage distribution for cumulative ~880 cycles measured from



10 different devices.

Figure S5. (a) I-V characteristic of the voltages measured after ~2years (b) Endurance of the device after ~2 years. (c) Switching voltage distribution of the device.

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